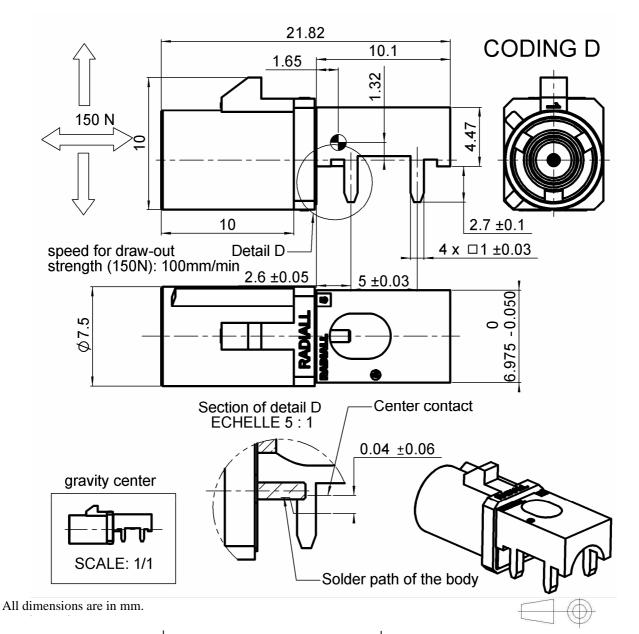
## **EDGE CARD - PIN IN PASTE VERSION**

# R197.160.D18

Series : **SMB CARLOCK** 



COMPONENTS	MATERIALS	PLATING (μm)	
BODY CENTER CONTACT OUTER CONTACT INSULATOR GASKET OTHERS PARTS	ZINC ALLOY BRASS - PTFE -	TIN FOR HI TEMPERATURE GOLD 0.5 OVER NICKEL 2	
-	-	UL CLASSIFICATION	COLOR
HOUSING	PA 4.6 30%GF	UL 94 V2  * According to	VIOLET RAL 4004 o FAKRA specification

**Issue:** 0943 C

In the effort to improve our products, we reserve the right to make changes judged to be



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## **PACKAGING**

Standard	Unit	Other
350	'W' option	Contact us

## **SPECIFICATION**

QS9000 SN 55228-2\*\*

## **ELECTRICAL CHARACTERISTICS**

Impedance 50  $\Omega$ 

Frequency **0-4** GHz VSWR **1.06\*** + **0.0130** x F(GHz) Maxi

Insertion loss  $0.03* \sqrt{F(GHz)}$  Maxi

RF leakage - ( F(GHz) dB Maxi
Voltage rating 335 Veff Maxi

 $\begin{array}{ccc} \mbox{Voltage rating} & \mbox{335} & \mbox{Veff Maxi} \\ \mbox{Dielectric withstanding voltage} & \mbox{1000} & \mbox{Veff mini} \\ \mbox{Insulation resistance} & \mbox{1000} & \mbox{M}\Omega \mbox{ mini} \\ \end{array}$ 

## **ENVIRONMENTAL**

Operating temperature -40/+110 ° C

Hermetic seal NA Atm.cm3/s

Panel leakage NA

## OTHER CHARACTERISTICS

Assembly instruction

#### Others:

\*COAX TRANSMISSION LINE ONLY \*\*Complaint except that 2D label does not include the shipping note number.

## **MECHANICAL CHARACTERISTICS**

Center contact retention

Axial force – Mating end
Axial force – Opposite end
Torque

10 N mini
NA N.cm mini

Recommended torque

Mating NA N.cm Panel nut NA N.cm

Mating life 100 Cycles mini

Weight **2,2300** g

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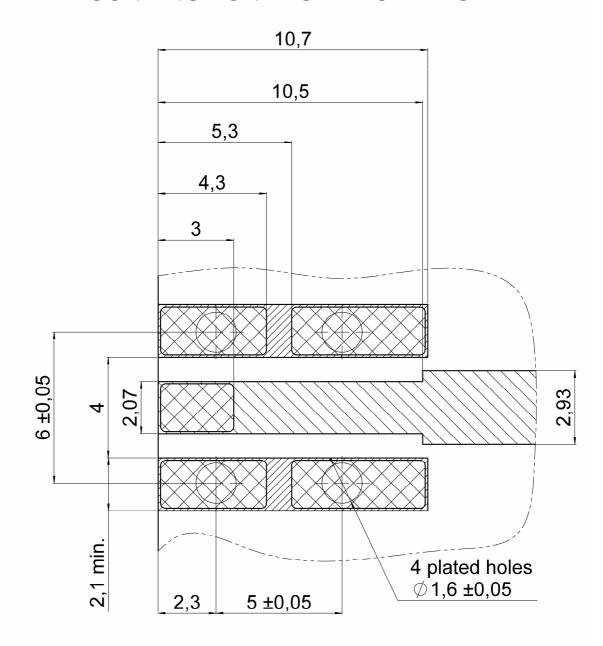


## **EDGE CARD - PIN IN PASTE VERSION**

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## MOUNTING ZONE FOR RECEPTACLE



Thickness of PCB: 1,6 mm. Material of PCB: FR4 ( $\varepsilon r = 4.6$ ).

Solder paste has to be printed onto the land of solder and into holes to permit Pin In Hole Reflow Ground track

Signal track

Land for solder

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## **EDGE CARD - PIN IN PASTE VERSION**

## SOLDER PROCEDURE

1. Deposition of solder paste 'Sn Ag4 Cu0.5' on mounting zone by screen printing application. We recommend a low residue flux.

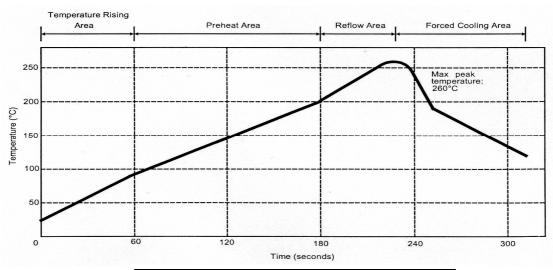
We advise a thickness of 0.2 millimetres min. (0.008 inch min.). Verify that the edges of the zone are clean.

2. Placement of the receptacle on the mounting zone with an automatic machine of 'pick and place' type.

Video camera is recommended for the positioning of the component. Adhesive agents must not be used on the receptacle.

- 3. Soldering by infra-red reflow. Below, please find the typical profile to use.
- 4. Cleaning of printed circuit boards.
- 5. Checking of solder joints and position of the component by visual inspection.

#### TEMPERATURE PROFILE



Value	Unit
1 - 4	°C/sec
260	°C
10	sec
20	sec
60	sec
-1 to -4	°C/sec
	1 - 4 260 10 20 60

**Issue:** 0943 C In the effort to improve our products, we reserve the right to make changes judged to be necessary.

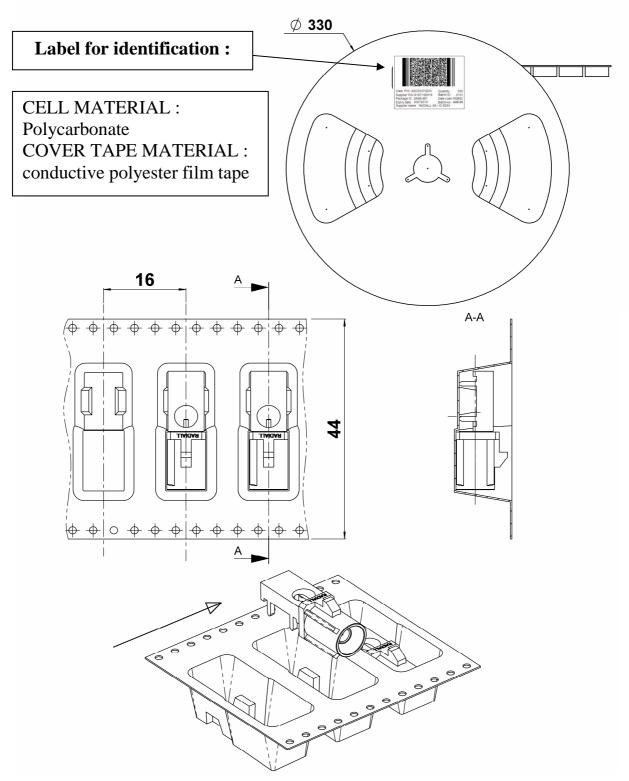


## **EDGE CARD - PIN IN PASTE VERSION**

# R197.160.D18

Series : **SMB CARLOCK** 

## **REEL PAKAGING PER 350**



**Issue:** 0943 C

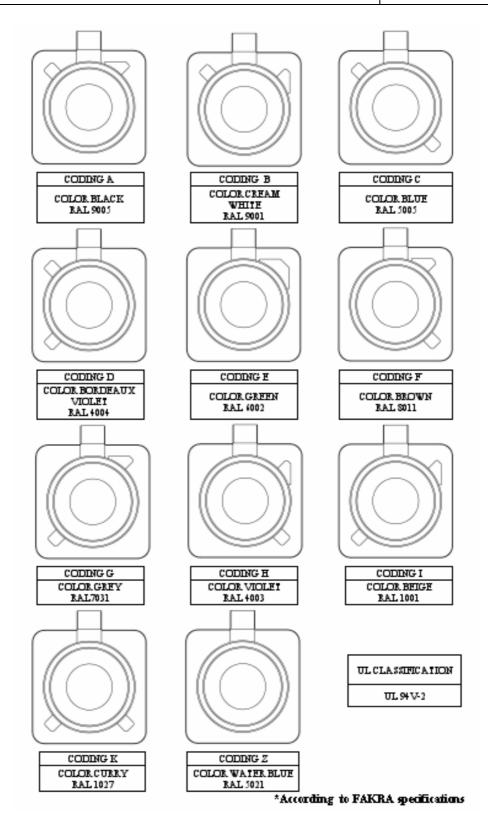
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## **EDGE CARD - PIN IN PASTE VERSION**

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To obtain other coding for the connector please change the letter by the needed coding letter into the Part Number

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